Photocouplers InGaAs Infrared LED & Photo Transistor

TLP182

1. Applications

- Switching Power Supplies
- Programmable Logic Controllers (PLCs)
- I/O Interface Boards

2. General

TLP182 is a low AC input type photocoupler that consists of phototransistor optically coupled to two antiparallel InGaAs infrared emitting diode in a SO6 package.

Since TLP182 is guaranteed high isolation voltage (3750 Vrms) and wide operating temperature range ($T_a = -55$ to 125 °C), it is suitable for high density surface mounting applications such as programmable controllers.

3. Features

- (1) Collector-emitter voltage: 80 V (min)
- (2) Current transfer ratio: 50 % (min) (@I_F = ±0.5 mA, V_{CE} = 5 V) GB Rank: 100 % (min) (@I_F = ±0.5 mA, V_{CE} = 5 V)
- (3) Isolation voltage: 3750 Vrms (min)
- (4) Operating temperature range: -55 to 125 $^{\circ}\text{C}$
- (5) Safety standards

UL-approved: UL1577, File No.E67349 cUL-approved: CSA Component Acceptance Service No.5A File No.E67349 VDE-approved: EN60747-5-5, EN60065 or EN60950-1 (Note 1) : EN62368-1 (Pending) (Note 1)

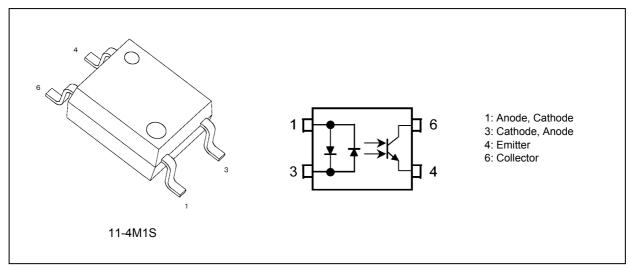
CQC-approved: GB4943.1, GB8898 Thailand Factory



仅适用干海拔 2000m 以下地区安全使用

Note 1: When a VDE approved type is needed, please designate the Option (V4).

4. Packaging and Pin Assignment



Start of commercial production 2013-09 2017-05-11 Rev.3.0

5. Mechanical Parameters

Characteristics	Min	Unit
Creepage distances	5.0	mm
Clearance	5.0	
Internal isolation thickness	0.4	

6. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25$ °C)

	Characteristics		Symbol	Note	Rating	Unit
LED	R.M.S. forward current		I _{F(RMS)}		±50	mA
	Input forward current derating	(T _a ≥ 90 °C)	$\Delta I_F / \Delta T_a$		-1.5	mA/°C
	Input forward current (pulsed)		I _{FP}	(Note 1)	±1	Α
	Input power dissipation		PD		100	mW
	Input power dissipation derating	$(T_a \ge 90 \ ^\circ C)$	$\Delta P_D / \Delta T_a$		-2.9	mW/°C
	Junction temperature		Tj		125	°C
Detector	Collector-emitter voltage		V _{CEO}		80	V
	Emitter-collector voltage		V _{ECO}		7	V
	Collector current		Ι _C		50	mA
	Collector power dissipation		P _C		150	mW
	Collector power dissipation derating	$(T_a \ge 25 \ ^\circ C)$	$\Delta P_C / \Delta T_a$		-1.5	mW/°C
	Junction temperature		Tj		125	°C
Common	Operating temperature		T _{opr}		-55 to 125	°C
	Storage temperature		T _{stg}		-55 to 125	°C
	Lead soldering temperature	(10 s)	T _{sol}		260	°C
	Total power dissipation		PT		200	mW
	Total power dissipation derating	$(T_a \ge 25 \ ^\circ C)$	$\Delta P_T / \Delta T_a$		-2.0	mW/°C
	Isolation voltage	AC, 60 s, R.H. ≤ 60 %	BVS	(Note 2)	3750	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Pulse width (PW) \leq 0.1 ms, f = 100 Hz

Note 2: This device is considered as a two-terminal device: Pins 1 and 3 are shorted together, and pins 4 and 6 are shorted together.

7. Electrical Characteristics (Unless otherwise specified, $T_a = 25$ °C)

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V _F		I _F = ±10 mA	1.1	1.25	1.4	V
	Input capacitance	Ct		V = 0 V, f = 1 MHz	_	60	_	pF
Detector	Collector-emitter breakdown voltage	V _{(BR)CEO}		I _C = 0.5 mA	80			V
	Emitter-collector breakdown voltage	V _{(BR)ECO}		I _E = 0.1 mA	7			V
	Dark Current	I _{DARK}		V _{CE} = 48 V	_	0.01	0.08	μA
				V _{CE} = 48 V, T _a = 85 °C		2	50	μA
	Collector-emitter capacitance	C _{CE}		V = 0 V, f = 1 MHz		10	_	pF

8. Coupled Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

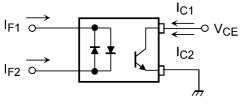
Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Current transfer ratio	I _C /I _F	(Note 1)	I_F = ±5 mA, V_{CE} = 5 V	50	_	600	%
			I_F = ±5 mA, V_{CE} = 5 V, Rank GB	100		600	
			I _F = ±0.5 mA, V _{CE} = 5 V	50	_	600	
			$I_F = \pm 0.5 \text{ mA}, V_{CE} = 5 \text{ V}, \text{ Rank GB}$	100	_	600	
Saturated current transfer ratio	$I_{C}/I_{F(sat)}$		I_F = ±1 mA, V_{CE} = 0.4 V	_	60	_	
			$I_F = \pm 1 \text{ mA}, V_{CE} = 0.4 \text{ V}, \text{Rank GB}$	30		_	
Collector-emitter saturation voltage	V _{CE(sat)}		I _C = 2.4 mA, I _F = ±8 mA	_	_	0.3	V
			$I_{\rm C}$ = 0.2 mA, $I_{\rm F}$ = ±1 mA	_	0.2	—	
			I_{C} = 0.2 mA, I_{F} = ±1 mA, Rank GB	_	_	0.3	
OFF-state collector current	I _{C(off)}		$V_{F} = \pm 0.7 V, V_{CE} = 48 V$	_	1	10	μA
Collector current ratio	I _C (ratio)		See Fig. 8.1 I _C (I _F = -5 mA) / I _C (I _F = 5 mA)	0.33	_	3	—

Note 1: See Table 8.1 for current transfer ratio.

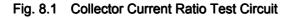
Table 8.1 Current Transfer Ratio (CTR) Rank (Note) (Unless otherwise specified, Ta = 25 °C)

Rank	Rank short code	Note	Test Condition	Current transfer ratio I _C /I _F (min)	Current transfer ratio I _C /I _F (max)	Marking of classification	Unit
Blank	_		I_F = ±5 mA, V_{CE} = 5 V	50	600	Blank, YE, GR, GB,	%
			I_F = ±0.5 mA, V_{CE} = 5 V			BL	
Y			I_F = ±5 mA, V_{CE} = 5 V	50	150	YE	
			I_F = ±0.5 mA, V_{CE} = 5 V				
GR	_		I_F = ±5 mA, V_{CE} = 5 V	100	300	GR	
			I_F = ±0.5 mA, V _{CE} = 5 V				
GB	_		I_F = ±5 mA, V_{CE} = 5 V	100	600	GB,GR,BL	
			I_F = ±0.5 mA, V _{CE} = 5 V				
BL	_		I _F = ±5 mA, V _{CE} = 5 V	200	600	BL	
			I_F = ±0.5 mA, V _{CE} = 5 V				

Note: Specify both the part number and a rank in this format when ordering. Example: TLP182(GB,E For safety standard certification, however, specify the part number alone. Example: TLP182(GB,E \rightarrow TLP182



$$I_{C}(ratio) = \frac{I_{C2}(I_{F} = I_{F2}, V_{CE} = 5 V)}{I_{C1}(I_{F} = I_{F1}, V_{CE} = 5 V)}$$



9. Isolation Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	CS	(Note 1)	V _S = 0 V, f = 1 MHz	_	0.8	—	pF
Isolation resistance	R _S	(Note 1)	V_S = 500 V, R.H. \leq 60 %	$1 imes 10^{12}$	10 ¹⁴	_	Ω
Isolation voltage	BVS	(Note 1)	AC, 60 s	3750	_	_	Vrms
			AC, 1 s in oil	_	10000		
			DC, 60 s in oil	_	10000	_	Vdc

Note 1: This device is considered as a two-terminal device: Pins 1 and 3 are shorted together, and pins 4 and 6 are shorted together.

10. Switching Characteristics (Unless otherwise specified, Ta = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Rise time	t _r		$V_{CC} = 10 \text{ V}, I_{C} = 2 \text{ mA},$		2	_	μS
Fall time	t _f		R _L = 100 Ω		3	_	
Turn-on time	t _{on}				3	_	
Turn-off time	t _{off}				3	_	
Turn-on time	t _{on}		See Fig. 10.1		1.3	_	
Storage time	ts		$R_{L} = 1.9 \text{ k}\Omega, \text{ V}_{CC} = 5 \text{ V},$ $I_{F} = \pm 16 \text{ mA}$		20	_	
Turn-off time	t _{off}				35	_	
Turn-on time	t _{on}		See Fig. 10.1		4	_	
Storage time	ts		R_L = 4.7 kΩ, V _{CC} = 5 V, I _F = ±1.6 mA		7	_	
Turn-off time	t _{off}				30	_	

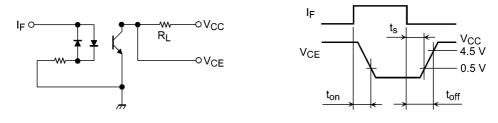
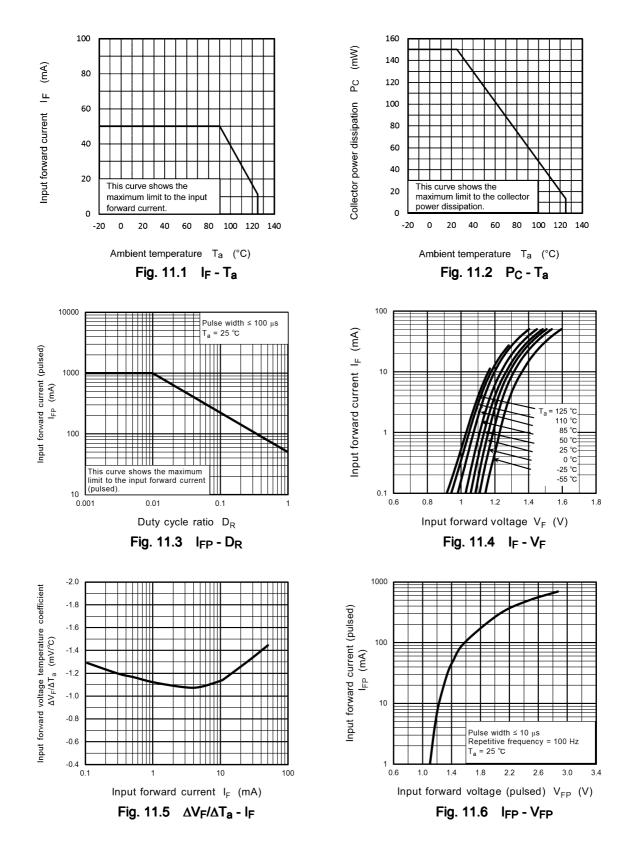
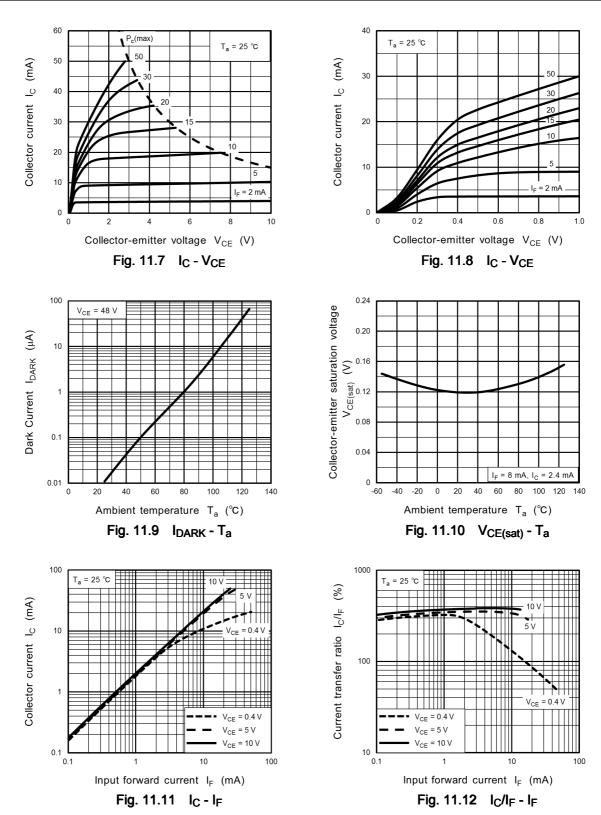
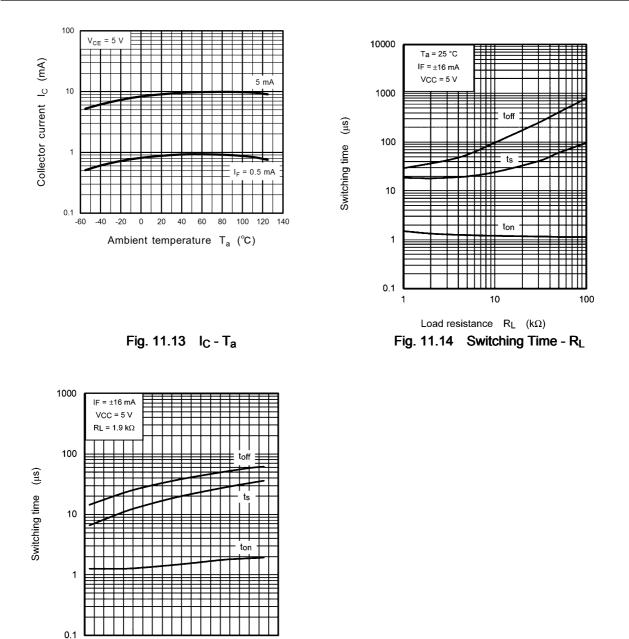


Fig. 10.1 Switching Time Test Circuit and Waveform

11. Characteristics Curves (Note)







Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

80 100 120 140

-60 -40 -20

0 20 40 60

Ambient temperature T_a (°C) Fig. 11.15 Switching Time - T_a

12. Soldering and Storage

12.1. Precautions for Soldering

The soldering temperature should be controlled as closely as possible to the conditions shown below, irrespective of whether a soldering iron or a reflow soldering method is used.

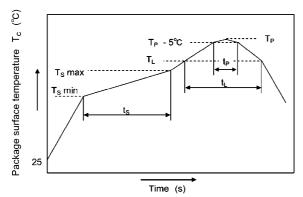
• When using soldering reflow.

The soldering temperature profile is based on the package surface temperature.

(See the figure shown below, which is based on the package surface temperature.)

Reflow soldering must be performed once or twice.

The mounting should be completed with the interval from the first to the last mountings being 2 weeks.



	Symbol	Min	Max	Unit
Preheat temperature	Ts	150	200	°C
Preheat time	ts	60	120	S
Ramp-up rate $(T_L \text{ to } T_P)$			3	°C/s
Liquidus temperature	TL	217		°C
Time above T_L	tL	60	150	s
Peak temperature	Τ _Ρ		260	°C
Time during which T_c is between (T _P – 5) and T_P	t₽		30	s
Ramp-down rate $(T_P \text{ to } T_L)$			6	°C/s

Fig. 12.1.1 An Example of a Temperature Profile When Lead(Pb)-Free Solder Is Used

• When using soldering flow Preheat the device at a temperature of 150 °C (package surface temperature) for 60 to 120 seconds.

Mounting condition of 260 °C within 10 seconds is recommended.

Flow soldering must be performed once.

When using soldering Iron

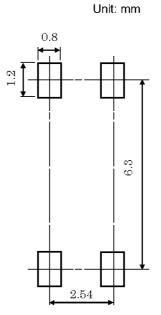
Complete soldering within 10 seconds for lead temperature not exceeding 260 °C or within 3 seconds not exceeding 350 °C

Heating by soldering iron must be done only once per lead.

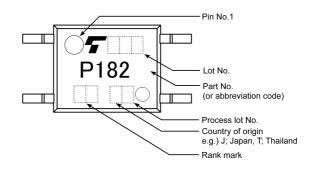
12.2. Precautions for General Storage

- Avoid storage locations where devices may be exposed to moisture or direct sunlight.
- Follow the precautions printed on the packing label of the device for transportation and storage.
- Keep the storage location temperature and humidity within a range of 5 $^\circ C$ to 35 $^\circ C$ and 45 % to 75 %, respectively.
- Do not store the products in locations with poisonous gases (especially corrosive gases) or in dusty conditions.
- Store the products in locations with minimal temperature fluctuations. Rapid temperature changes during storage can cause condensation, resulting in lead oxidation or corrosion, which will deteriorate the solderability of the leads.
- When restoring devices after removal from their packing, use anti-static containers.
- Do not allow loads to be applied directly to devices while they are in storage.
- If devices have been stored for more than two years under normal storage conditions, it is recommended that you check the leads for ease of soldering prior to use.

13. Land Pattern Dimensions (for reference only)



14. Marking



15. EN60747-5-5 Option (V4) Specification

- Part number: TLP182 (Note 1)
- The following part naming conventions are used for the devices that have been qualified according to option (V4) of EN60747.

Example: TLP182(V4GR-TL,E(T

V4: EN60747 option

GR: CTR rank

TL: Tape type (L direction: TPL)

E: [[G]]/RoHS COMPATIBLE (Note 2)

T: Domestic ID (Country/Region of origin: Thailand)

Note 1: Use TOSHIBA standard type number for safety standard application.

e.g., TLP182(V4GR-TL,E(T \rightarrow TLP182

Note 2: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

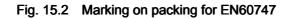
Description	Symbol	Rating	Unit
Application classification			
for rated mains voltage \leq 150 Vrms for rated mains voltage \leq 300 Vrms		I-IV I-III	_
Climatic classification		55 / 125 / 21	_
Pollution degree		2	_
Maximum operating insulation voltage	VIORM	707	Vpeak
Input to output test voltage, Method A V_{pr} = 1.6 × VIORM, type and sample test t_p = 10 s, partial discharge < 5 pC	Vpr	1131	Vpeak
Input to output test voltage, Method B V _{pr} =1.875 × VIORM, 100 % production test t _p = 1 s, partial discharge < 5 pC	Vpr	1330	Vpeak
Highest permissible overvoltage (transient overvoltage, t _{pr} = 60 s)	VTR	6000	Vpeak
Safety limiting values (max. permissible ratings in case of fault, also refer to thermal derating curve) current (input current IF, P _{so} = 0) power (output or total power dissipation) temperature	lsi Pso Ts	250 400 150	mA mW °C
Insulation resistance $V_{IO} = 500 \text{ V}, \text{ T}_{a} = 25 \text{ °C}$ $V_{IO} = 500 \text{ V}, \text{ T}_{a} = 100 \text{ °C}$ $V_{IO} = 500 \text{ V}, \text{ T}_{a} = \text{ T}_{s}$	Rsi	≥ 10 ¹² ≥ 10 ¹¹ ≥ 10 ⁹	Ω

Fig. 15.1 EN60747 Insulation Characteristics

		• • • •
Insulation Related Parameters	Symbol	TLP182
Minimum creepage distance	Cr	5.0 mm
Minimum clearance	CI	5.0 mm
Minimum insulation thickness	ti	0.4 mm
Comparative tracking index	СТІ	175

Note: This photocoupler is suitable for **safe electrical isolation** only within the safety limit data. Maintenance of the safety data shall be ensured by means of protective circuits.





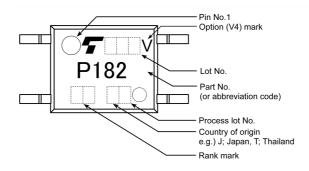
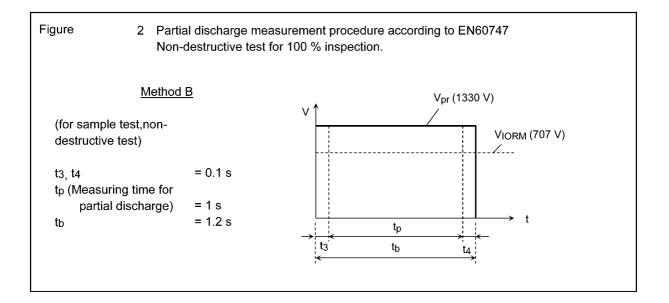
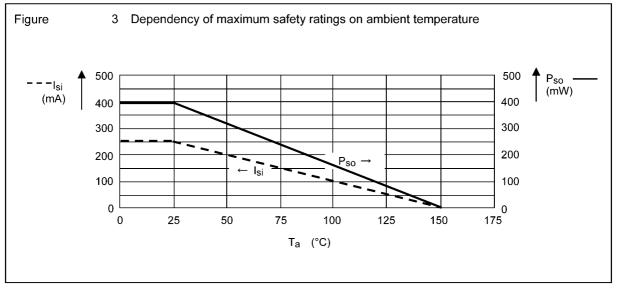


Fig. 15.3 Marking Example (Note)

Note: The above marking is applied to the photocouplers that have been qualified according to option (V4) of EN60747.

0.0	-	asurement procedure according to EN60747 Julification and sampling tests.
Method		VINITIAL (6 KV)
(for type and sampling destructive tests)	iesis,	V _{pr} (1131 V)
t1, t2	= 1 to 10 s	VIORM (707 V)
t3, t4	= 1 s	
tp (Measuring time for		
partial discharge)	= 10 s	$0 \xrightarrow{\mu} t$
tb	= 12 s	t_3 t_p t_4
tini	= 60 s	t1 tini t2 tb







16. Embossed-Tape Packing (TPL), (TPR) Specification for Mini-Flat Photocouplers

16.1. Applicable Package

Package Name	Product Type	
SO6	Mini flat coupler	

16.2. Product Naming Conventions

Type of package used for shipment is denoted by a symbol suffix after a part number. The method of classification is as below.

Example)TLP182(GR-TPL,E(T

Part number: TLP182 CTR rank: GR Tape type: TPL(L direction) [[G]]/RoHS COMPATIBLE: E (Note 1) Domestic ID (Country/Region of origin: Thailand): T

Note 1: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

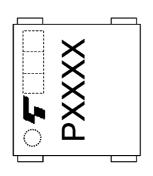
RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

16.3. Tape Dimensions Specification

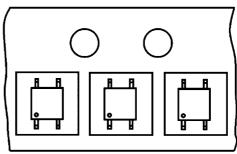
Таре Туре	Division	Packing Amount (A unit per reel)
TPL	L direction	3000
TPR	R direction	3000

16.3.1. Orientation of Device in Relation to Direction of Feed

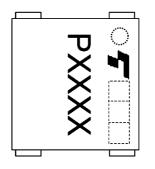
Device orientation in the carrier cavities as shown in the following figure.

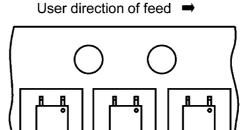


User direction of feed 👄



L direction





R direction

Fig. 16.3.1.1 Device Orientation

16.3.2. Packing Quantity

 $3000 \mathrm{~pcs}$ per reel

16.3.3. Empty Cavities

Characteristics	Criterion	Remarks
Occurrences of 2 or more successive empty cavities	0 device	Within any given 40-mm section of tape, not including leader and trailer
Single empty cavity	6 devices (max) per reel	Not including leader and trailer

16.3.4. Tape Leader and Trailer

The start end of the tape has 50 or more empty cavities. The hub end of the tape has 50 or more empty cavities and 2 empty turns for a cover tape.

16.3.5. Tape Dimensions

Е

F

G

 K_0

1.75

8.0

4.0

2.6

Internal space

Tape material: Plastic (for protection against static electricity)

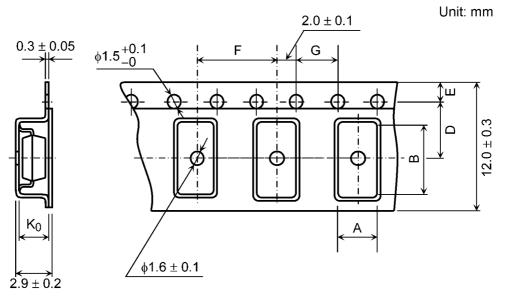


Fig. 16.3.5.1	Tape dimensions
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Table 10.3.5.1			
Syı	mbol	Dimension	Remark
	A	4.0	—
	В	7.6	
	D	5.5	Center line of embossed cavity and sprocket hole

Distance between tape edge and sprocket hole center

Cumulative error +0.1/-0.3 (max) per 10 sprocket holes

Cumulative error +0.1/-0.3 (max) per 10 empty cavities holes

Table 16.3.5.1	Tape Dimensions	(unit: mm,	tolerance: ±0.1)
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TLP182

16.3.6. Reel Specification

Material: Plastic

TOSHIBA

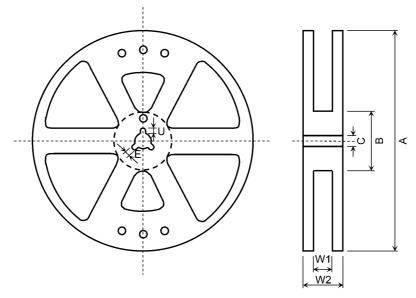
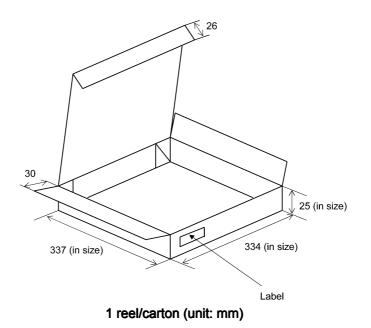


Fig. 16.3.6.1 Reel dimensions

Table 16.3.6.1	Reel Dimensions (unit:
	mm)

Symbol	Dimension	
A	$\phi 330 \pm 2$	
В	$\varphi 80 \pm 1$ / $\varphi 100 \pm 1$	
С	$\phi 13 \pm 0.5$	
E	2.0 ± 0.5	
U	4.0 ± 0.5	
W1	13.5 ± 0.5	
W2	17.5 ± 1.0	

16.4. Packing (Note)



Note: Taping reel diameter: \$330 mm

16.5. Label Format

(1) Carton: The label provides the part number, quantity, lot number, the Toshiba logo, etc.

(2) Reel: The label provides the part number, the taping name, quantity, lot number, etc.

16.6. Ordering Information

When placing an order, please specify the part number, CTR rank, tape type and quantity as shown in the following example.

Example)TLP182(GR-TPL,E(T 6000 pcs

Part number: TLP182 CTR rank: GR Tape type: TPL (L direction) [[G]]/RoHS COMPATIBLE: E (Note 1) Domestic ID (Country/Region of origin: Thailand): T Quantity (must be a multiple of 3000): 6000 pcs

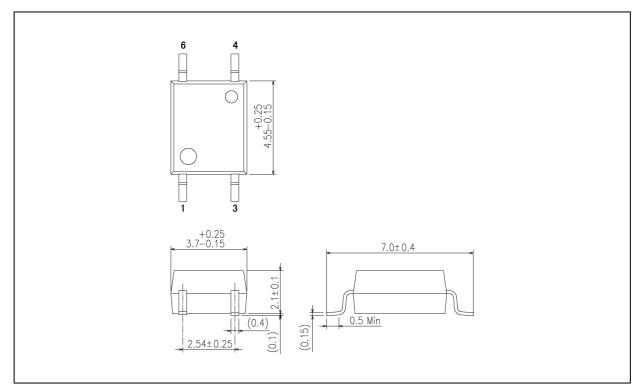
Note 1: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility. RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.



Package Dimensions

TLP182

Unit: mm



Weight: 0.08 g (typ.)

Package Name(s)

TOSHIBA: 11-4M1S

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